TOSHIBA Diode Silicon Epitaxial Schottky Barrier Type

# DSR520CT

## **High-Speed Switching Applications**

• Low reverse current: I<sub>R</sub> = 5 μA (max)

## **Absolute Maximum Ratings (Ta = 25°C)**

Characteristic	Symbol	Rating	Unit	
Maximum (peak) reverse voltage	$V_{RM}$	32	V	
Reverse voltage	V <sub>R</sub>	30	٧	
Maximum (peak) forward current	I <sub>FM</sub>	300	mA	
Average forward current	Io	200	mA	
Surge current (10 ms)	I <sub>FSM</sub>	1	Α	
Power dissipation	Р	150*	mW	
Junction temperature	Tj	125	°C	
Storage temperature range	T <sub>stg</sub>	-55 to 125	°C	
Operating temperature range	T <sub>opr</sub>	-40 to 100	°C	

<sup>\*</sup> Mounted on a glass-epoxy circuit board of 20 mm × 20 mm, pad dimensions of 4 mm × 4 mm.

Unit: mm

VALUE OF ST2

CST2

Unit: mm

COTHOD

O.6±0.05

O.5±0.03

O.05±0.03

D.05±0.03

O.05±0.03

Weight: 0.7 mg (typ.)

Note: Using continuously under heavy loads (e.g. the application of high

temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## **Electrical Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit	
Forward voltage	V <sub>F (1)</sub>	_	I <sub>F</sub> = 1 mA	1	0.21	_		
	V <sub>F (2)</sub>	_	I <sub>F</sub> = 10 mA	1	0.28	0.39	V	
	V <sub>F (3)</sub>	_	I <sub>F</sub> = 200 mA	_	0.52	0.6		
Reverse current	I <sub>R</sub>	_	V <sub>R</sub> = 30 V	_	_	5	μΑ	
Total capacitance	C <sub>T</sub>	_	V <sub>R</sub> = 0, f = 1 MH <sub>z</sub>		18	_	pF	

# **Equivalent Circuit (top view)**



#### Marking



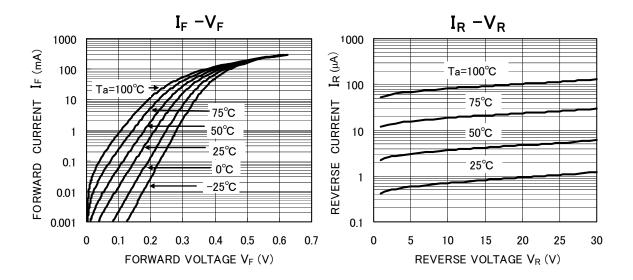
# **Handling Precaution**

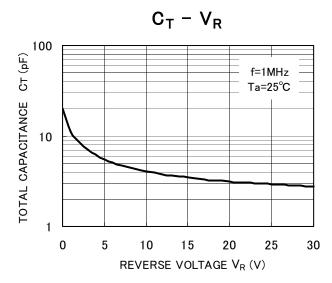
Schottky barrier diodes have reverse current characteristic compared to the other diodes.

There is a possibility SBD may cause thermal runaway when it is used under high temperature or high voltage.

Please take forward and reverse loss into consideration during design.

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